

# **POC-700 Series**

Intel<sup>®</sup> Core<sup>™</sup> i3-N305/ Atom<sup>®</sup> x7425E Ultra-compact Embedded Computer with 4x PoE+, USB 3.2, and MezIO<sup>®</sup> Interface

# CEF©

Intel<sup>®</sup> Alder Lake Core<sup>™</sup> i3-N305 processor 15W with 8 E-Cores or Atom<sup>®</sup> x7425E

- · Up to 16GB DDR5-4800 SODIMM
- $\cdot\,$  -25 °C to 70 °C rugged wide temperature operation
- $\cdot\,$  4x GbE ports PoE+ / 4x USB3.2 Gen 2 with screw-lock
- · M.2 2280 M key SATA socket

**Key Features** 

- · DP++ / HDMI 1.4b dual display outputs
- · 4-CH isolated DI + 4-CH isolated DO
- Front I/O access DIN-mounting design
- MezlO<sup>®</sup> compatible

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#### Introduction

POC-700 is Neousys' next-generation ultra-compact embedded controller, with a choice of the latest Intel® Alder Lake i3-N305 or x7425E processor that is capable of delivering up to 1.3x the CPU performance when compared to previous POC-500 series.

Neousys POC-700 is powered by Intel's Alder Lake i3-N305 featuring 8-core/ 8-thread processor with 32EUs UHD Graphics or Atom<sup>®</sup> x7425E featuring 4-core/ 4-thread with 24EUs UHD Graphics to support Intel OpenVINO<sup>™</sup> for Al inference capabilities. The systems adopts DDR5-4800 to offer up to 1.8x the memory bandwidth over DDR4 to boost overall system performance. It also has four USB3.2 Gen2, and four GigE PoE+ ports with screw lock mechanisms to connect and secure industrial cameras for machine vision applications. Display output wise, there are HDMI and DP video outputs to support high-definition display devices. As for connections and expansions, POC-700 features isolated DIO for device monitoring/control, M.2 2280 M key for SATA SSD and a mini-PCIe socket for wireless WiFi, LTE/5G or CAN bus device.

Measuring just 64 x 116 x 176mm, the ultra-compact POC-700 can easily fit into confined spaces and is a seamless upgrade from POC-500 series with identical footprint. Benefiting from the performance gains of the latest Intel CPU, wide-temperature fanless design, and ample interfaces for industrial cameras and I/Os, POC-700 is perfect for machine vision and smart city applications.

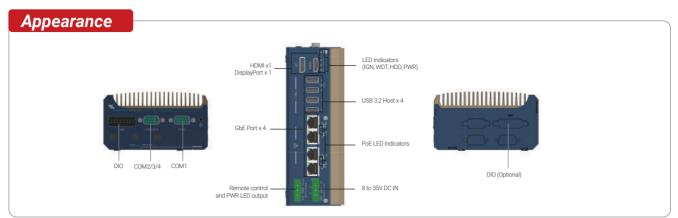
## Specifications

	POC-715	POC-712		POC-715	POC-712
System Core			Power Supply		
_	Intel <sup>®</sup> Alder Lake Core <sup>™</sup> i3-N305	Intel <sup>®</sup> Alder Lake Atom <sup>®</sup> x7425E	DC Input	1x 3-pin pluggable terminal block f	or 8 to 35V DC input
Processor	processor (8C/8T, 1.8/3.8 GHz, 15W TDP)	processor (4C/4T, 1.5 /3.4 GHz, 12W TDP)	Remote Ctrl. &LED Output	1x 3-pin pluggable terminal block for remote control and PWR LED output	
Graphics	Integrated Intel <sup>®</sup> UHD Graphics with 32EUs	Integrated Intel <sup>®</sup> UHD Graphics with 24EUs	Mechanical		
Memory	Up to 16 GB DDR5-4800 SDRAM (one SODIMM socket)		Dimension	64 (W) x 116 (D) x 176 (H) mm	
TPM	Supports TPM 2.0 (fTPM/ dTPM)	dTPM) Weight 1.2 kg			
Panel I/O Interface		Mounting	DIN-rail mount (standard) or wall-mount (optional)		
Ethernet	4x Gb Ethernet ports by Intel <sup>®</sup> I350-AM4		Fan	Optional external-accessible 80mm x 80mm fan for system heat dissipation	
PoE+	IEEE 802.3at PoE+ on port #1~ 4 -		Environmental	· · · · F · · · ·	
Native Video Port	1x DP++, Supporting 4096 x 2160 resolution 1x HDMI1.4b, Supporting 3840 x 2160 30Hz		Operating Temperature	-25°C ~ 70°C*	
Serial Port	1x Software-programmable RS-232/422/485 ports (COM1) 3x 3-wire RS-232 ports (COM2/3/4) or 1x RS-422/485 port (COM2)		Storage	-40°C ~ 85°C	
USB	4x USB 3.2 Gen2 ports with screw-lock		Temperature		
Isolated DIO	4-CH isolated DI and 4-CH isolated DO		Humidity	10%~90% , non-condensing	
Storage Interface		Vibration	Operating, MIL-STD-810G, Method 514.6, Category 4		
M.2	1x M.2 2280 M key socket (PCle	Gen3 x1) for NVMe SSD storage	Shock	Operating, MIL-STD-810G, Method 516.6, Procedure I, Table	516.6-II
(supports SATA signal)		Safety	EN62368-1		
Expansion Bus			EMC	CE/ FCC Class A, according to EN	55032 & EN 55024
Mini-PCle	· · · · · · · · · · · · · · · · · · ·	ket with internal micro SIM socket	* For sub-zero and over 60°C operating temperature, a wide temperature HDD or Solid State Disk (SSD) is required.		
Expandable I/O	1x MezIO <sup>®</sup> expansion interface f	or Neousys MezlO <sup>®</sup> modules			

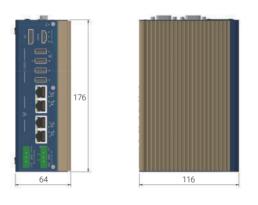
#### POC-700 Series



Unit : mm



### Dimensions



# **Ordering Information**

Model No.	Product Description
POC-715	Intel <sup>®</sup> Core <sup>™</sup> i3-N305 Ultra-Compact Embedded Computer with 4x PoE+, 4x USB 3.2 and MezIO <sup>®</sup> Interface
POC-712	Intel <sup>®</sup> Atom <sup>®</sup> x7425E Ultra-Compact Embedded Computer with 4x GbE, 4x USB3.2 and MezIO <sup>®</sup> Interface

# **Optional Accessories**

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PA-60W-OW	60W AC/DC power adapter with 12V, 5A DC output, cord end terminals for terminal block. Operating temperature : -30 to 70°C
PA-120W-OW	120W AC/DC power adapter with 12V, 10A DC output, cord end terminals for terminal block. Operating temperature : -30 to 60°C
Wmkit-V-POC500	Wall-mount assembly for POC-500 and POC-700 series, vertical type
Wmkit-H-POC500	Wall-mount assembly for POC-500 and POC-700 series, horizontal type
Cbl-DB9F-3DB9M-15CM	1x DB9 (Female) to 3x DB9 (Male), length: 15CM
AccsyBx-FAN-POC-700	Fan assembly for POC-700 series, 80x80x15 mm
MezIO <sup>®</sup> Modules	
MezIO <sup>®</sup> -C180-50	MezlO <sup>®</sup> module with 4x RS-232/ 422/ 485 ports and 4x RS-232 ports
MezIO <sup>®</sup> -C181-50	MezlO <sup>®</sup> module with 4x RS-232/ 422/ 485 ports and 4x RS-422/ 485 ports
MezIO <sup>®</sup> -R11	MezlO <sup>®</sup> module with SATA port for 2.5" HDD/ SSD
MezIO <sup>®</sup> -R12	MezIO <sup>®</sup> module with SATA port for 2.5" HDD/ SSD, 4-CH isolated DI and 4-CH isolated DO
MezIO <sup>®</sup> -V20	MezIO <sup>®</sup> module with ignition power control function and 1x mini-PCIe socket for in-vehicle usage
MezIO <sup>®</sup> -U4-30	MezlO <sup>®</sup> module with 4x USB 3.1 ports